

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>XIN ZHONG</td> <td>10/15/2013</td> </tr> <tr> <td>DASHAN GAO</td> <td>10/15/2013</td> </tr> <tr> <td>NING BI</td> <td>10/15/2013</td> </tr> <tr> <td>STEVEN DOUGLAS LAVER</td> <td>10/15/2013</td> </tr> <tr> <td>SCOTT DAVID BEITH</td> <td>10/15/2013</td> </tr> <tr> <td>DIARMUID MACCORMACK</td> <td>10/30/2013</td> </tr> </tbody> </table>		Name	Execution Date	XIN ZHONG	10/15/2013	DASHAN GAO	10/15/2013	NING BI	10/15/2013	STEVEN DOUGLAS LAVER	10/15/2013	SCOTT DAVID BEITH	10/15/2013	DIARMUID MACCORMACK	10/30/2013
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RECEIVING PARTY DATA															
<table border="1"> <tr> <td>Name:</td> <td>QUALCOMM Incorporated</td> </tr> <tr> <td>Street Address:</td> <td>5775 Morehouse Drive</td> </tr> <tr> <td>City:</td> <td>San Diego</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>92121-1714</td> </tr> </table>		Name:	QUALCOMM Incorporated	Street Address:	5775 Morehouse Drive	City:	San Diego	State/Country:	CALIFORNIA	Postal Code:	92121-1714				
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PROPERTY NUMBERS Total: 2															
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Application Number:	14036947														
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CORRESPONDENCE DATA															
Fax Number:	(801)606-2774														
Phone:	801-537-1700														
Email:	wla-admin@austin-rapp.com														
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>															
Correspondent Name:	WESLEY L. AUSTIN														
Address Line 1:	170 S. MAIN ST., STE. 735														
Address Line 4:	SALT LAKE CITY, UTAH 84101														
ATTORNEY DOCKET NUMBER:	132429; 132429P1														

OP \$80.00 14036947

NAME OF SUBMITTER:	WESLEY L. AUSTIN
Signature:	/Wesley L. Austin/
Date:	11/25/2013
<p>Total Attachments: 8</p> <p>source=132429_Assignment#page1.tif</p> <p>source=132429_Assignment#page2.tif</p> <p>source=132429_Assignment#page3.tif</p> <p>source=132429_Assignment#page4.tif</p> <p>source=132429_Assignment#page5.tif</p> <p>source=132429_Assignment#page6.tif</p> <p>source=132429_Assignment#page7.tif</p> <p>source=132429_Assignment#page8.tif</p>	

ASSIGNMENT

WHEREAS, WE,

1. **Xin Zhong**, a citizen of the **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
2. **Dashan Gao**, a citizen of **China**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
3. **Ning Bi**, a citizen of the **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
4. **Steven Douglas Laver**, a citizen of the **Canada**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
5. **Scott David Beith**, a citizen of the **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,
6. **Diarmuid MacCormack**, a citizen of the **United States of America**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **San Diego, CA**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **TRACKER ASSISTED IMAGE CAPTURE** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said **INVENTIONS**, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto **ASSIGNEE**, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said **INVENTIONS**, including all patent applications therefor that may have been filed or may be filed hereafter for said **INVENTIONS** in the United States, including but not limited to U.S. Application No(s). **14/036,947** filed **September 25, 2013**, Qualcomm Reference No. **132429**, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/835,414**, filed **June 14, 2013**, Qualcomm Reference

No. **132429P1**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 10/15/2013 Xin Zhong
LOCATION DATE

Done at San Diego, on 10/15/2013 Dashan Gao
LOCATION DATE

Done at San Diego, on 10/15/2013 Ning Bi
LOCATION DATE

Done at _____, on _____ Steven Douglas Laver
LOCATION DATE

Done at _____, on _____ Scott David Beith
LOCATION DATE

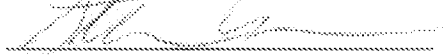
Done at _____, on _____ Diarmuid MacCormack
LOCATION DATE

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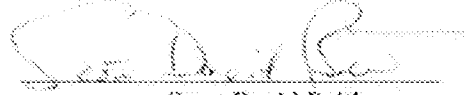
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6. **Diarmuid MacCormack**, a citizen of the **Canada**, having a mailing address located at **5775 Morehouse Drive, San Diego, CA 92121-1714** and a resident of **Montreal, Canada**,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **TRACKER ASSISTED IMAGE CAPTURE** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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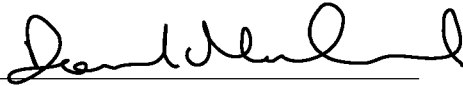
Done at _____, on _____
LOCATION DATE **Xin Zhong**

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LOCATION DATE **Dashan Gao**

Done at _____, on _____
LOCATION DATE **Ning Bi**

Done at _____, on _____
LOCATION DATE **Steven Douglas Laver**

Done at _____, on _____
LOCATION DATE **Scott David Beith**

Done at Montreal, on 30 Oct 2013
LOCATION DATE 
Diarmuid MacCormack